

SANYO Semiconductors DATA SHEET

N-Channel Silicon MOSFET

ATP213 — General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · Large current.
- · Slim package.
- 4V drive.
- · Halogen free compliance.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		60	V
Gate-to-Source Voltage	V _{GSS}		±20	V
Drain Current (DC)	ID		50	А
Drain Current (PW≤10μs)	IDP	PW≤10μs, duty cycle≤1%	150	А
Allowable Power Dissipation	PD	Tc=25°C	50	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		37	mJ
Avalanche Current *2	IAV		25	А

Note :*1 VDD=10V, L=100 μ H, IAV=25A *2 L \leq 100 μ H, Single pulse

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
	Symbol		min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	60			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =60V, V _{GS} =0V			1	μА
Gate-to-Source Leakage Current	IGSS	VGS=±16V, VDS=0V			±10	μΑ

Marking: ATP213 Continued on next page.

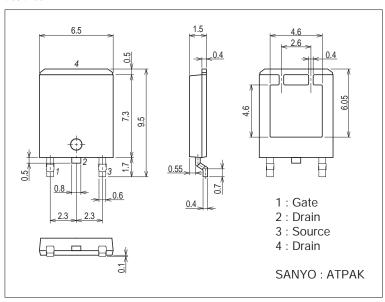
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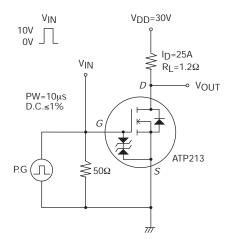
Parameter	Symbol	Conditions	Ratings			1.1-14
			min	typ	max	Unit
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =25A		55		S
Static Drain-to-Source On-State Resistance	RDS(on)1	ID=25A, VGS=10V		12	16	mΩ
	R _{DS} (on)2	I _D =13A, V _{GS} =4.5V		15	21	mΩ
	R _{DS} (on)3	I _D =7A, V _G S=4V		17	26	mΩ
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		3150		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		310		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		190		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		23		ns
Rise Time	t _r	See specified Test Circuit.		170		ns
Turn-OFF Delay Time	td(off)	See specified Test Circuit.		230		ns
Fall Time	tf	See specified Test Circuit.		150		ns
Total Gate Charge	Qg	V _{DS} =30V, V _{GS} =10V, I _D =50A		58		nC
Gate-to-Source Charge	Qgs	V _{DS} =30V, V _{GS} =10V, I _D =50A		10.5		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =30V, V _{GS} =10V, I _D =50A		12.5		nC
Diode Forward Voltage	V _{SD}	I _S =50A, V _{GS} =0V		1.01	1.2	V

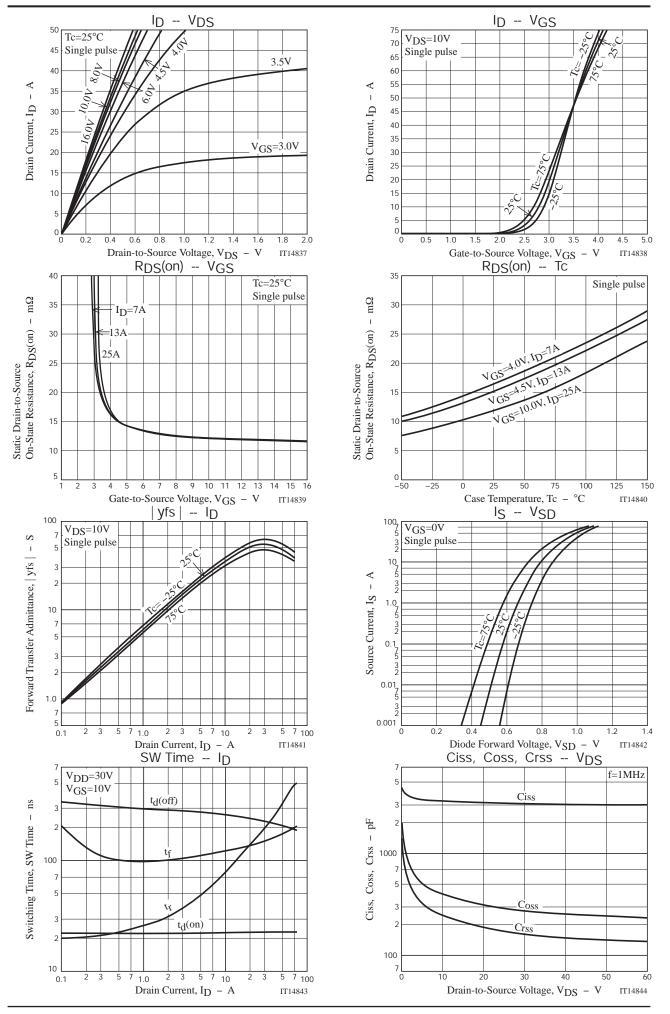
Package Dimensions

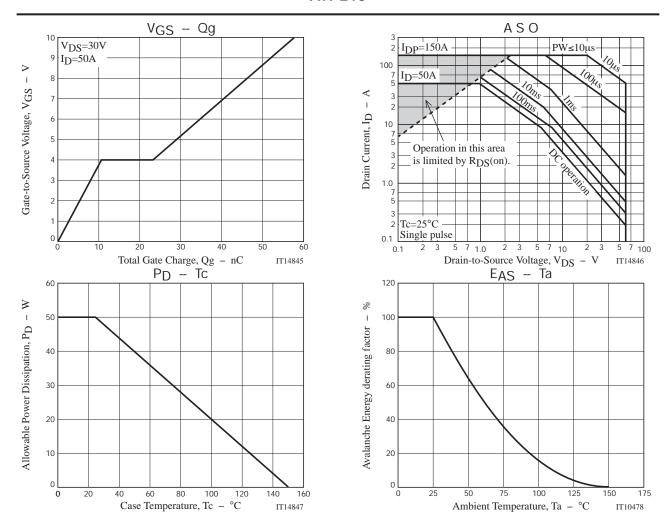
unit : mm (typ) 7057-001



Switching Time Test Circuit







Note on usage: Since the ATP213 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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